

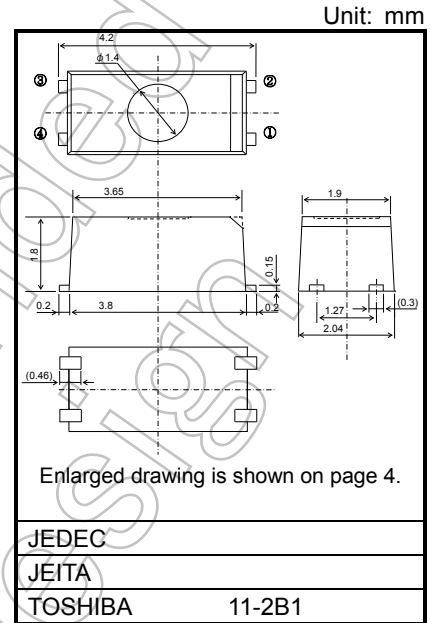
## TLP3220

Memory Tester  
 Logic Tester  
 Measurement Instrument

The TOSHIBA TLP3220 is a super small-outline photorelay, suitable for surface-mount assembly. The TLP3220 consists of an infrared emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

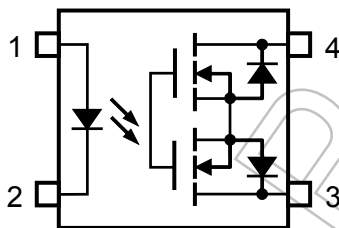
### Features

- 4 pin SSOP (SSOP4) : 1.8 mm high, 1.27 mm pitch
- 1-Form-A
- Peak off-state voltage : 100 V (min)
- Trigger LED current : 5 mA (max)
- On-state current : 80 mA (max)
- On-state resistance : 14 Ω (max), 8 Ω (typ.)
- Output capacitance : 8 pF (max), 6 pF (typ.)
- Isolation voltage : 1500 Vrms (min)
- UL-recognized : UL 1577, File No.E67349



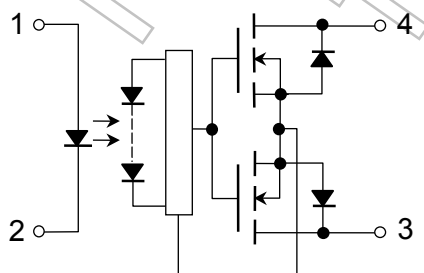
Weight: 0.03 g (typ.)

### Pin configuration (top view)



- 1 : Anode
- 2 : Cathode
- 3 : Drain
- 4 : Drain

### Schematic



Start of commercial production  
 2004-06

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I <sub>F</sub>	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
	Reverse voltage	V <sub>R</sub>	5	V
	Diode power dissipation	P <sub>D</sub>	50	mW
	Diode power dissipation derating (Ta > 25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction temperature	T <sub>j</sub>	125	°C
Detector	Off-State output terminal voltage	V <sub>OFF</sub>	100	V
	On-State current	I <sub>ON</sub>	80	mA
	On-State current derating (Ta ≥ 25°C)	ΔI <sub>ON</sub> /°C	-0.8	mA/°C
	Output power dissipation	P <sub>O</sub>	96	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP <sub>O</sub> /°C	-0.96	mW / °C
	Junction temperature	T <sub>j</sub>	125	°C
Storage temperature range		T <sub>stg</sub>	-40 to 125	°C
Operating temperature range		T <sub>opr</sub>	-20 to 85	°C
Lead soldering temperature (10 s)		T <sub>sol</sub>	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BVS	1500	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1): Device considered a two-terminal device: Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

## Precautions

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

## Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Supply voltage	V <sub>DD</sub>	—	—	80	V
Forward current	I <sub>F</sub>	10	—	30	mA
Operating temperature	T <sub>opr</sub>	25	—	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

## Individual Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	—	—	10	μA
	Capacitance	C <sub>T</sub>	V = 0 V, f = 1 MHz	—	15	—	pF
Detector	Off-state current	I <sub>OFF</sub>	V <sub>OFF</sub> = 80 V	—	—	200	pA
			V <sub>OFF</sub> = 100 V	—	—	1	μA
	Capacitance	C <sub>OFF</sub>	V = 0 V, f = 100 MHz, t < 1 s	—	6	8	pF

## Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I <sub>FT</sub>	I <sub>ON</sub> = 80 mA	—	1	5	mA
Return LED current	I <sub>FC</sub>	I <sub>OFF</sub> = 1 μA	0.2	—	—	mA
On-state resistance	R <sub>ON</sub>	I <sub>ON</sub> = 80 mA, I <sub>F</sub> = 10 mA, t = 10 ms	—	8	14	Ω

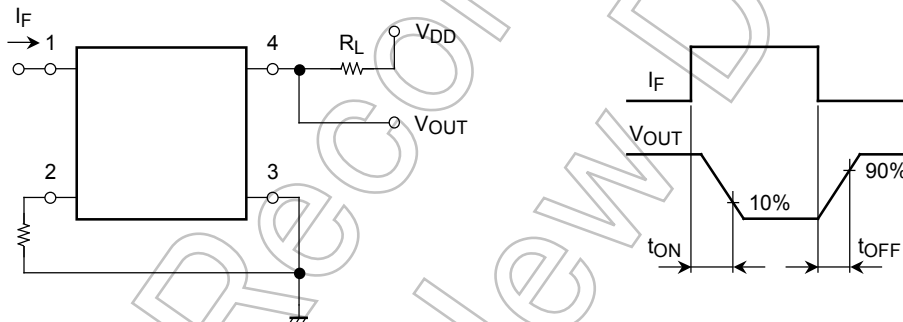
## Isolation Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C <sub>S</sub>	V <sub>S</sub> = 0 V, f = 1 MHz	—	0.6	—	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	—	Ω
Isolation voltage	BV <sub>S</sub>	AC, 60 s	1500	—	—	V <sub>rms</sub>

## Switching Characteristics (Ta = 25°C)

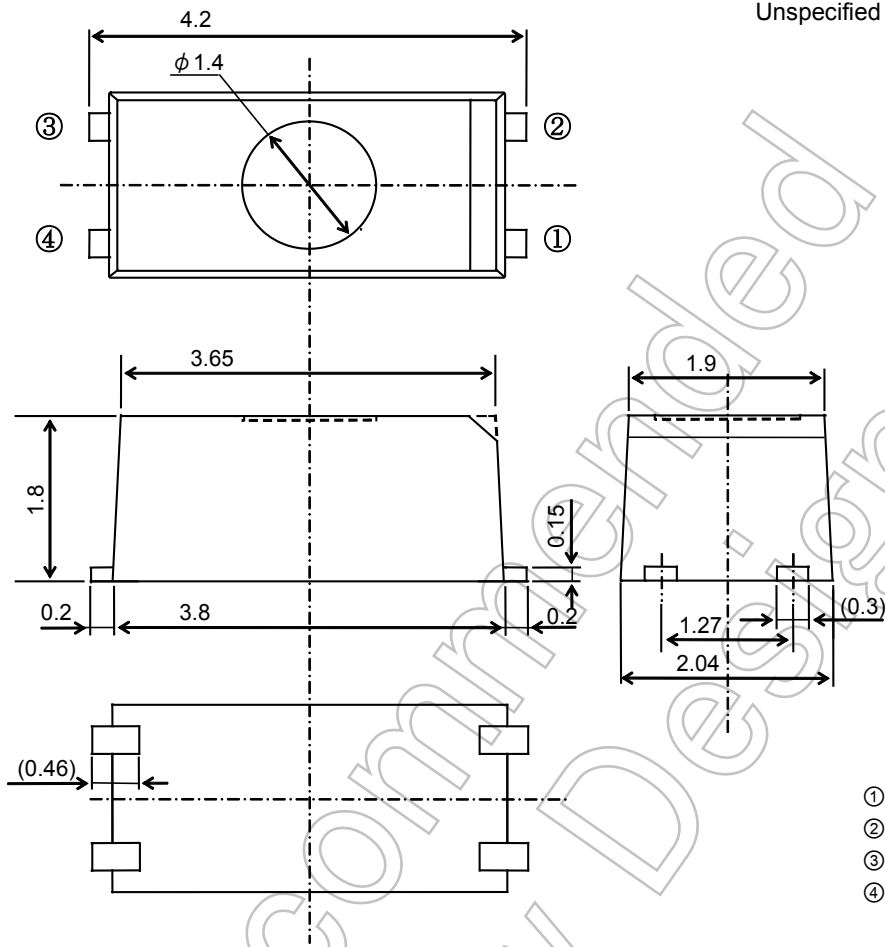
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> = 200 Ω (Note 2)	—	100	300	μs
Turn-off time	t <sub>OFF</sub>	V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA	—	100	300	

(Note 2): switching time test circuit



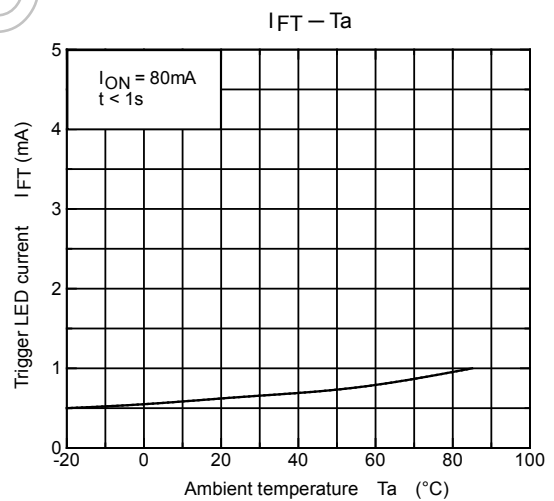
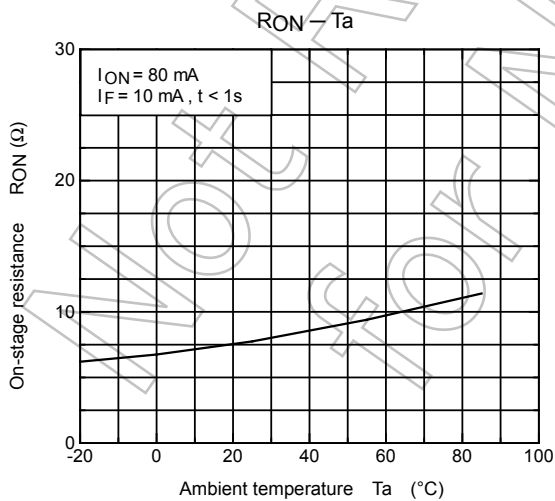
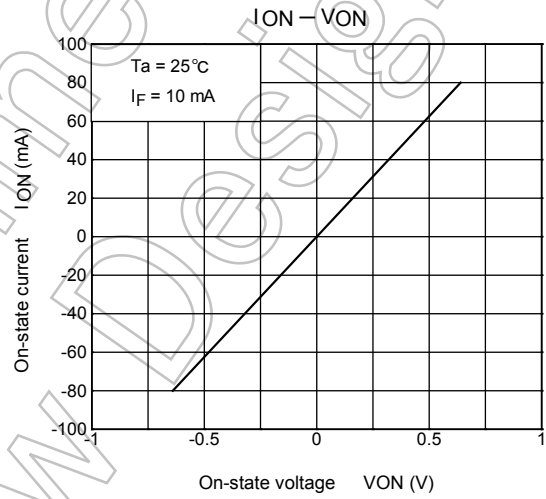
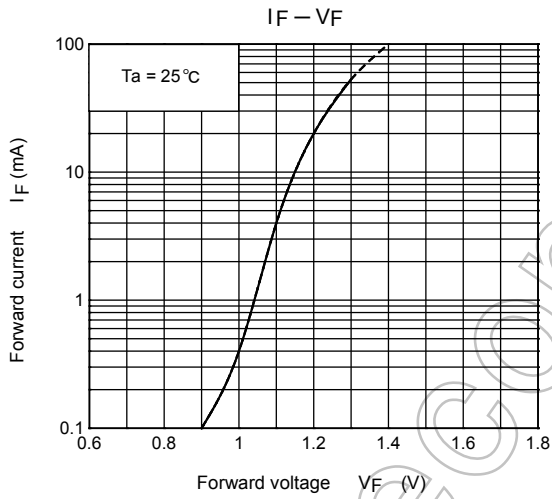
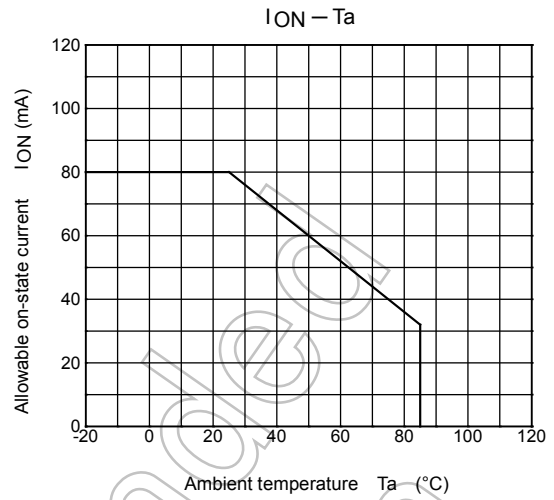
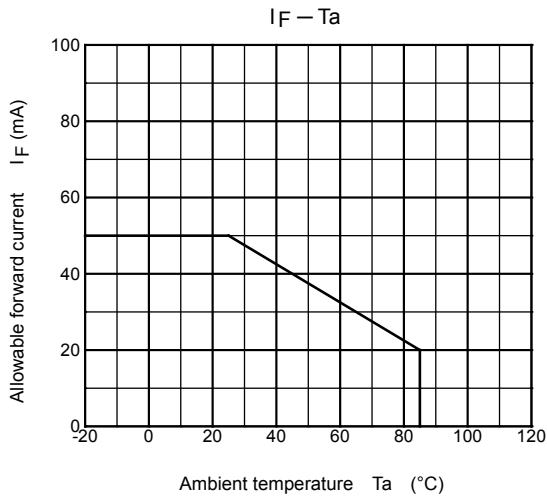
**Package Dimensions**

Unit: mm  
 Unspecified tolerance: ±0.1

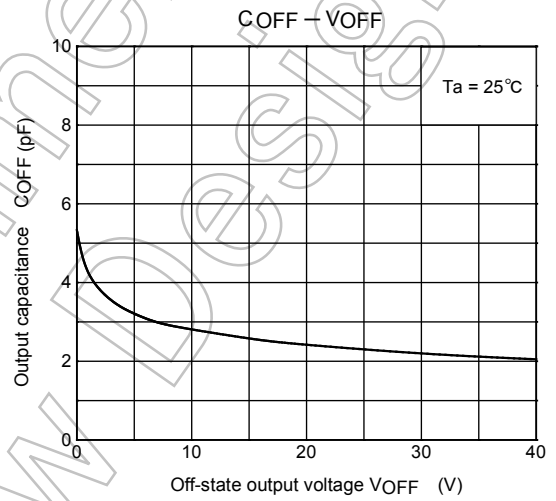
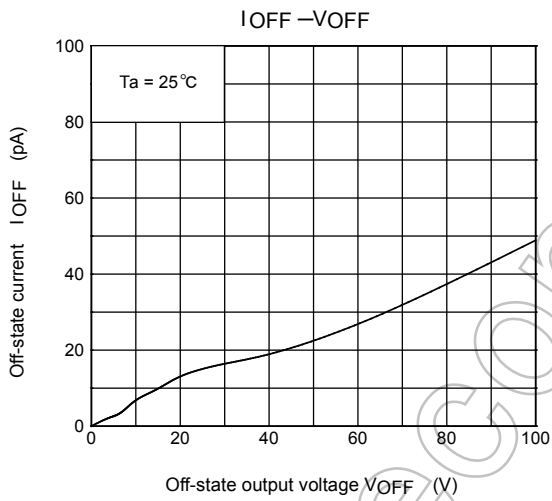
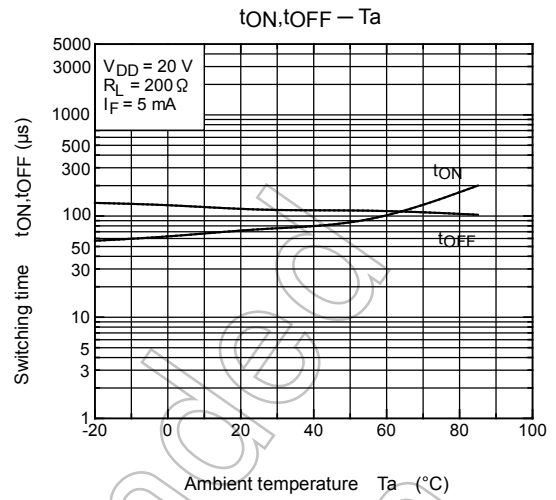
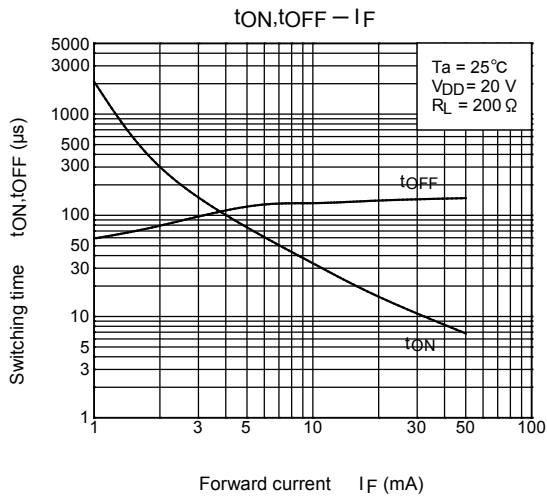


- ① : Anode
- ② : Cathode
- ③ : Drain
- ④ : Drain

Not Recommended for New Design



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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